Supplier Information  Company Name * Company Unique ID Unique ID Authority Response Date * Response Document ID 2012-02-22  Contact Name * Title - Contact Phone - Contact * (805) 389-2742 rreader @semtech.com  Authorized Representative * Title - Representative Phone - Representative * (805) 389-2742 rreader @semtech.com  ROYA READER  ROYA READER  ROYA READER  ROYA READER  Response Document ID  Duplicate Contact -> Authorized Representative Representative * Supplier Comments or URL for Additional Information rreader @semtech.com  Requester Item Number Mfr Item Number Mfr Item Name Effective Date Version Manufacturing Site Weight * UOM Unit Type  SM24.TCT 300 Watt, 24V TVS Diode Array China 8,949 mg Each  Alternate Recommendation  Manufacturing Process Information  Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cyc  Matte Tin (Sn)  Unique ID Authority Response Date * Response Date * Response Document ID  Duplicate Contact -> Authorized Representative Supplier Comments or URL for Additional Information  Manufacturing Site Weight * UOM Unit Type  Alternate Item Comments  Number of Reflow Cyc  Matte Tin (Sn)  1 Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cyc  Matter Tin (Sn)  3 Seconds 3	ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	© Co	terial Compo pyright 2005. IPC, Bannoo nternational and Pan-Ameri	kburn, Illinois	. All rights reserv	tion with lower	level p	arts, the	declaratio	n encon	npasses	all lower	level mate	erials for	which th	e item is an assembly ne manufacturer had declaration.
Company Name * Company Unique ID Unique ID Authority Response Date * 2012-02-22	1752-2 1.1	_		-1752 Standa		''			Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Infor							
SEMTECH CORPORATION  2012-02-22  Contact Name * ROYA READER  ROYA READER  Requester Item Number  Requester Item Number  SM24.TCT  Alternate Recommendation  Manufacturing Process Information  Terminal Plating / Grid Array Material  Terminal Plating / Grid Array Material  Title - Contact  Phone - Contact * (805) 389-2742  Remail - Contact * Email - Contact * Email - Contact * Duplicate Contact -> Authorized Representative Re	Supplier Information															
Contact Name * ROYA READER  Authorized Representative * ROYA READER  Authorized Representative * ROYA READER  Authorized Representative * ROYA READER  Requester Item Number  Requester Item Number  Mfr Item Number  Mfr Item Number  Mfr Item Name  Smail - Contact * Roya Reader@semtech.com  Requester Item Number  Mfr Item Number  Mfr Item Number  Mfr Item Name  Effective Date  Version  Alternate Item Comments  Manufacturing Site  Meight * UOM Unit Type  Alternate Recommendation  Manufacturing Process Information  Terminal Plating / Grid Array Material  Terminal Base Alloy  CU Alloy  1 Peak Process Body Temperature  Max Time at Peak Temperature  Number of Reflow Cyc  30 seconds  3	Company Name *		Company Unique ID		Unique ID Au	ıthority	Respo	nse Date	*		Respons	se Docum	nent ID			
ROYA READER  Authorized Representative * Title - Representative   Phone - Representative * (805) 389-2742   Phone	SEMTECH CORPORATION	ON					2012-0	)2-22								
ROYA READER Authorized Representative * Title - Representative * Phone - Representative * ROYA READER REQUESTENTIAL PROPERSENTATIVE * Supplier Comments or URL for Additional Information Requester Item Number ROYA READER ROYA ROYA ROYA ROYA ROYA ROYA ROYA ROYA	Contact Name *		Title - Contact		Phone - Con	tact *	Email	- Contac	t *		5	P .	0 1 1	Λ (1		1
Requester Item Number	ROYA READER				(805) 389-27	42	rreade	er@semte	ch.com		Du	uplicate	Contact -	-> Autho	orizea Re	epresentative
Requester Item Number	Authorized Representati	ive *	Title - Representative	е	Phone - Rep	resentative *	Email	- Repres	entative	*	Supplier	Commer	nts or URL	for Add	ditional Ir	nformation
SM24.TCT 300 Watt, 24V TVS Diode Array China 8.949 mg Each Alternate Recommendation  Manufacturing Process Information  Terminal Plating / Grid Array Material Terminal Base Alloy J-STD-020 MSL Rating Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycle Matte Tin (Sn)  CU Alloy 1  China 8.949 mg Each Alternate Item Comments  Factorial Peak Process Body Temperature Max Time at Peak Temperature Number of Reflow Cycle Alternate Item Comments  CU Alloy 1  CU Alloy 1  CU Alloy 1  CO	ROYA READER				(805) 389-27	42	rreade	er@semte	ech.com							
Alternate Recommendation  Manufacturing Process Information  Terminal Plating / Grid Array Material  Terminal Plating / Grid Array Material  Terminal Plating / Grid Array Material  Terminal Base Alloy  CU Alloy  1  Alternate Item Comments  Alternate Item Comments  Peak Process Body Temperature   Max Time at Peak Temperature   Number of Reflow Cycles   Alloy   Alternate Item Comments	Requester Item Numbe	r	Mfr Item Number		Mfr Item Name		Effectiv	e Date	Version	Manufa	cturing S	ite	Weight *	UC	DM	Unit Type
Manufacturing Process Information       Terminal Plating / Grid Array Material     Terminal Base Alloy     J-STD-020 MSL Rating     Peak Process Body Temperature     Max Time at Peak Temperature     Number of Reflow Cyc       Matte Tin (Sn)     CU Alloy     1     260 °C     30 seconds     3			SM24.TCT		300 Watt, 24\	/ TVS Diode Arra	ıy			China		8	8.949	mg	3	Each
Terminal Plating / Grid Array Material  Terminal Base Alloy  Terminal Base Alloy  Deak Process Body Temperature  Max Time at Peak Temperature  Number of Reflow Cyc  Terminal Plating / Grid Array Material  Terminal Base Alloy  1  260 C  30 seconds 3	Alternate Recommend	ation							Alternate	Item Co	mments					•
Matte Tin (Sn)         CU Alloy         1         260 C         30 seconds         3	Manufacturing Proces	ss In	formation									•				
	Terminal Plating / Grid Array	Materi	ial	Terminal B	ase Alloy	J-STD-020 MSL Ra	ating	Peak Proc	ess Body	Temper	ature Ma	ax Time at	Peak Tem	perature	Number	of Reflow Cycles
Comments	Matte Tin (Sn)			CU Alloy	,			2	<b>260</b> C		<b>30</b> Se		conds	3		
Confinence	Comments			1		1										

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Save the fields in Import fields from a Clear all of the Lock the fields on this **Export Data** Import Data Reset Form Lock Supplier Fields this form to a file file into this form fields on this form form to prevent changes **RoHS Material Composition Declaration Declaration Type \*** Detailed Rohs Directive Rohs Definition: Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenvls (PBB). Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium 2002/95/EC Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply. 1 - Item(s) does not contain RoHS restricted substances per the definition above Supplier Acceptance \* Accepted **RoHS Declaration \*** Exemptions: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions. **Declaration Signature** 

Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## **Homogeneous Material Composition Declaration for Electronic Products**

**Subltem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

**Substance Instructions:** [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Line Functions: +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

Item/SubItem				Homogeneous	Weight	Unit of			Level	Substance Category			Substance	CAS	Evennt	Weight	Unit of	Tolerance		PPM
	Name			Material	weight	Measure			Levei	Substance Category			Substance	CAS	Exempt	vveignt	Measure	-	+	FFIVI
+1 -1	DIE CHIP	+M	-М	Si, Doped	0.2671	mg	+C	-C	Supplier		+S	-S	Silicon (Si)	7440-21-3		0.2671	mg			29,844
+1 -1	LEAD FRAME	+M	-м	CDA194	2.6309	mg	+C	-C	Supplier		+S	-S	Copper (Cu)	7440-50-8		2.5625	mg			286,35
	-				•						+S	-s	Iron (Fe)	7439-89-6		0.0631	mg			7,056
											+S	-s	Phosphorous (P)	7723-14-0		0.0021	mg			235
											+S	-s	Zinc (Zn)	7440-66-6		0.0032	mg			353
		+N	-М	Die Attached Pac	0.1034	mg	+C	-c	Supplier		+S	-s	Silver (Ag)	7440-22-4		0.1034	mg			11,559
+1 -1	BONDING WIRE	+M	-М	Gold Wire	0.0256	mg	+C	-C	Supplier		+S	-S	Gold (Au)	7440-57-5		0.0256	mg			2,859
+1 -1	MOLDING COMPO	+M	-М	EME-G600	5.5586	mg	+C	-C	Supplier		+S	-S	Epoxy Resin	Proprietary		0.2779	mg			31,059
	-				•						+S	-s	Phenol Resin	Proprietary		0.2779	mg			31,059
											+S	-s	Bismuth Compound	Proprietary		0.0028	mg			311
											+S	-s	Silicon Dioxide (SiO2)	60676-86-0		4.861	mg			543,21
											+S	-s	Cresol Novolac	29690-82-2		0.1112	mg			12,424
											+S	-s	Carbon Black	1333-86-4		0.0278	mg			3,106
+1 -1	DIE ATTACHED EP	(+M	-М	84-1LMISR4	0.1075	mg	+C	-c	Supplier		+S	-s	Silver (Ag)	7440-22-4		0.0806	mg			9,007
	-				•						+S	-s	Epoxy Resin	Proprietary		0.0215	mg			2,402
											+S	-s	Curing Agent & Harden	Proprietary		0.0054	mg			600
+1 -1	FINISH PLATING	+M	l -M	Tin Solder	0.2555	mg	+C	-c	Supplier		+S	-S	Tin (Sn)	7440-31-5		0.2555	mg			28,548